NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. REFER JEDEC MO-288
3. COPLANARITY APPLIES TO THE EXPOSED THERMAL PAD AS WELL AS THE TERMINALS.
4. RECOMMENDED LAND PATTERN IS FOR REFERENCE ONLY.
5. THERMAL PAD SOLDERING AREA (MESH STENCIL DESIGN IS RECOMMENDED).

DESCRIPTION: 24-contact, Extra Thin Fine Pitch QFN, X1QFN
PACKAGE CODE: XEAQ (XEAQ24)
DOCUMENT CONTROL #: PD-2226
DATE: 3/22/17